

### SPICE Device Model Si8429DB Vishay Siliconix

### P-Channel 1.2V (G-S) MOSFET

#### **CHARACTERISTICS**

- P-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS

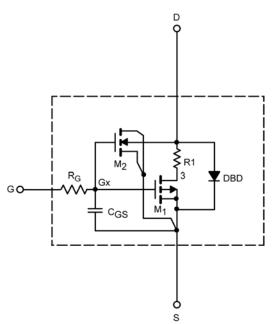
- Apply for both Linear and Switching Application
- Accurate over the –55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

#### DESCRIPTION

The attached spice model describes the typical electrical characteristics of the p-channel vertical DMOS. The subcircuit model is extracted and optimized over the -55 to  $125^{\circ}$ C temperature ranges under the pulsed 0-V to 5-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

#### SUBCIRCUIT MODEL SCHEMATIC

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched  $C_{gd}$  model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.



This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.



| Parameter                                     | Symbol              | Test Condition   | Simulated<br>Data | Measured<br>Data | Unit |
|---|---------------------|--|-------------------|------------------|------|
| Static  |                     |  |                   |                  |      |
| Gate Threshold Voltage                        | V <sub>GS(th)</sub> | $V_{DS}$ = $V_{GS}$ , $I_D$ = -250 $\mu$ A                   | 0.60              |                  | V    |
| Drain-Source On-State Resistance <sup>a</sup> | r <sub>DS(on)</sub> | $V_{GS}$ = -4.5 V, I <sub>D</sub> = -1 A                     | 0.031             | 0.029            | А    |
| Drain-Source On-State Resistance <sup>a</sup> | ۲ <sub>DS(on)</sub> | $V_{GS}$ = -2.5 V, I <sub>D</sub> = -1 A                     | 0.036             | 0.035            | Ω    |
|   |                     | $V_{GS}$ = -1.8 V, I <sub>D</sub> = -1 A                     | 0.043             | 0.043            |      |
|   |                     | $V_{GS} = -1.5 \text{ V}, \text{ I}_{D} = -1 \text{ A}$      | 0.049             | 0.051            |      |
|   |                     | $V_{GS}$ = -1.2 V, I <sub>D</sub> = -1 A                     | 0.066             | 0.065            |      |
| Forward Transconductance <sup>a</sup>         | 9 <sub>fs</sub>     | $V_{DS} = -4 V, I_{D} = -1 A$                                | 10                |                  | S    |
| Diode Forward Voltage <sup>a</sup>            | V <sub>SD</sub>     | $I_{\rm S}$ = -1 A, $V_{\rm GS}$ = 0 V                       | - 0.60            | - 0.70           | V    |
| Dynamic <sup>b</sup>                          |                     |  | •                 |                  |      |
| Input Capacitance                             | C <sub>iss</sub>    | $V_{DS}$ = -4 V, $V_{GS}$ = 0 V, f = 1 MHz                   | 1793              | 1640             | pF   |
| Output Capacitance                            | C <sub>oss</sub>    |  | 588               | 590              |      |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>    |  | 379               | 380              |      |
| Total Gate Charge                             | Qg                  | $V_{\rm DS}$ = -4 V, $V_{\rm GS}$ = -5 V, $I_{\rm D}$ = -1 A | 18                | 24               | nC   |
|   |                     | $V_{DS}$ = -4 V, $V_{GS}$ = -4.5 V, $I_{D}$ = -1 A           | 16                | 21               |      |
| Gate-Source Charge                            | Q <sub>gs</sub>     |  | 1.8               | 1.8              |      |
| Gate-Drain Charge                             | $Q_gd$              |  | 3.7               | 3.7              |      |

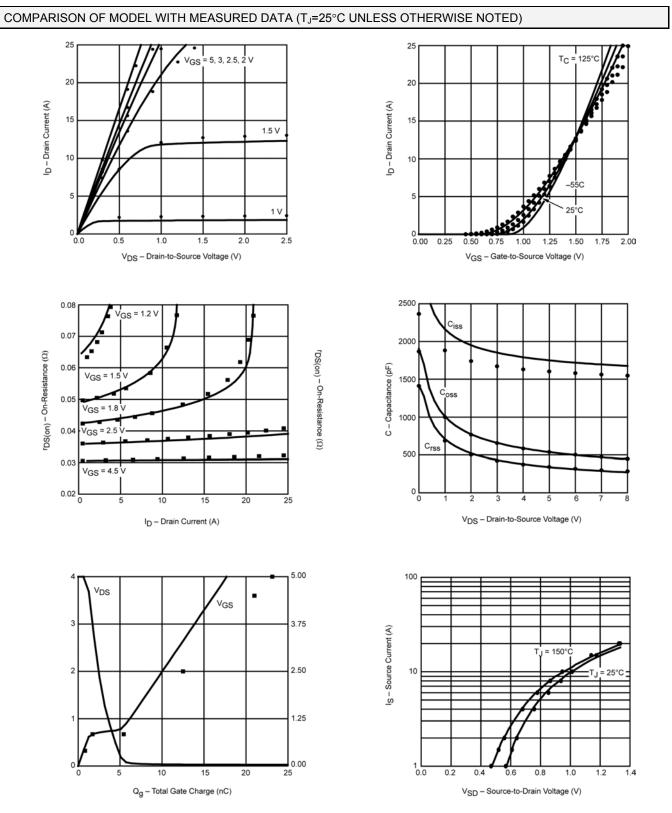
Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2%. b. Guaranteed by design, not subject to production testing.



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Note: Dots and squares represent measured data.



Vishay

## Disclaimer

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